# (19) World Intellectual Property Organization

International Bureau



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(43) International Publication Date 28 February 2008 (28.02.2008)

## (10) International Publication Number WO 2008/023846 A3

- (51) International Patent Classification: G01L 1/18 (2006.01) G01L 5/16 (2006.01)
- (21) International Application Number:

PCT/JP2007/066952

- (22) International Filing Date: 24 August 2007 (24.08.2007)
- (25) Filing Language:

(26) Publication Language:

English

(30) Priority Data:

2006-227467

24 August 2006 (24.08.2006)

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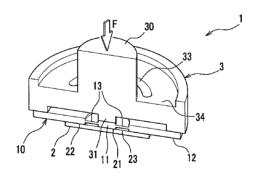
- (74) Agent: ISONO, Michizo; c/o Isono International Patent Office, Sabo-Kaikan Annex, 7-4, Hirakawa-Cho 2-chome, Chiyoda-ku, Tokyo, 1020093 (JP).
- (81) Designated States (unless otherwise indicated, for every kind of national protection available): AE, AG, AL, AM, AT, AU, AZ, BA, BB, BG, BH, BR, BW, BY, BZ, CA, CH, CN, CO, CR, CU, CZ, DE, DK, DM, DO, DZ, EC, EE, EG, ES, FI, GB, GD, GE, GH, GM, GT, HN, HR, HU, ID, IL, IN, IS, KE, KG, KM, KN, KP, KR, KZ, LA, LC, LK, LR, LS, LT, LU, LY, MA, MD, ME, MG, MK, MN, MW, MX, MY, MZ, NA, NG, NI, NO, NZ, OM, PG, PH, PL, PT, RO, RS, RU, SC, SD, SE, SG, SK, SL, SM, SV, SY, TJ, TM, TN, TR, TT, TZ, UA, UG, US, UZ, VC, VN, ZA, ZM, ZW.
- (84) Designated States (unless otherwise indicated, for every kind of regional protection available): ARIPO (BW, GH, GM, KE, LS, MW, MZ, NA, SD, SL, SZ, TZ, UG, ZM, ZW), Eurasian (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM), European (AT, BE, BG, CH, CY, CZ, DE, DK, EE, ES, FI, FR, GB, GR, HU, IE, IS, IT, LT, LU, LV, MC, MT, NL, PL, PT, RO, SE, SI, SK, TR), OAPI (BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW, ML, MR, NE, SN, TD, TG).

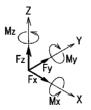
#### Published:

with international search report

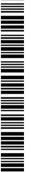
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#### (54) Title: FORCE SENSOR USING A SEMICONDUCTIVE SUBSTRATE





(57) Abstract: A force sensor 1 includes: a force sensor chip 2 including an action portion 21, a connecting portion 23 on which strain resistive elements are disposed, and a support portion 22 for supporting the action portion 21 and the connecting portion 23; an attenuator 3 including an input portion 30 to which an external force is input, a fixing portion 32 for fixing the force sensor chip 2, and a transmission portion 31 for attenuating the external force and transmitting the attenuated external force to the action portion 21; a first glass member 11 disposed between the action portion 21 and the transmission portion 31 and a second glass member 12 disposed between the support portion 22 and the fixing portion 32, through which glass members 11, 12 the force sensor chip 2 and the attenuator 3 are joined. A single or more glass beams 13 joins the first glass member 11 and the second glass member 12 together as a single member.



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- before the expiration of the time limit for amending the claims and to be republished in the event of receipt of amendments
- (88) Date of publication of the international search report: 17 April 2008

## INTERNATIONAL SEARCH REPORT

International application No PCT/JP2007/066952

A. CLASSIFICATION OF SUBJECT MATTER INV. G01L5/16 G01L1/18							
According to International Patent Classification (IPC) or to both national classification and IPC							
ļ	SEARCHED						
Minimum documentation searched (classification system followed by classification symbols) GOIL							
Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched							
Electronic data base consulted during the international search (name of data base and, where practical, search terms used)							
EPO-In	ternal, WPI Data						
C. DOCUMENTS CONSIDERED TO BE RELEVANT							
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A	US 5 526 700 A (H.A. AKEEL)	1,9,10					
	18 June 1996 (1996-06-18) column 4, line 9 - line 44; figures						
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Α	EP 1 653 208 A2 (HONDA MOTOR CO., LTD.) 1,9,10 3 May 2006 (2006-05-03)						
	page 11, line 29 - line 54; figures 11,12						
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	abstract; figures 1a,4a						
	<del></del>						
Further documents are listed in the continuation of Box C. X See patent family annex.							
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which is cited to establish the publication date of another citation or other special reason (as specified)  "Y" document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the							
*O' document referring to an oral disclosure, use, exhibition or other means document is combined with one or more other such documents, such combination being obvious to a person skilled in the art.							
later than the priority date claimed  *&' document member of the same patent family  Date of the actual completion of the international search  Date of mailing of the international search report							
5 February 2008 14/02/2008							
Name and mailing address of the ISA/  Authorized officer							
European Patent Office, P.B. 5818 Patentlaan 2 NL - 2280 HV Rijswijk Tok (291.70) 240, 240, 71, 241,651 and pl							
Tel. (+31-70) 340-2040, Tx. 31 651 epo nl, Fax: (+31-70) 340-3016		Van Assche, Peter					

## INTERNATIONAL SEARCH REPORT

Information on patent family members

International application No
PCT/JP2007/066952

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